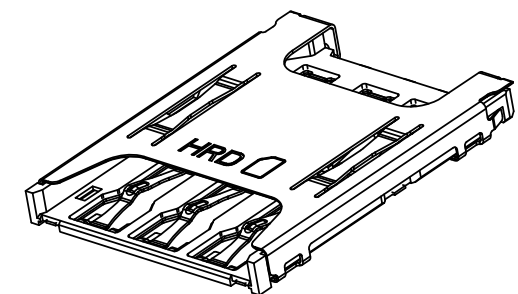



- NOTES:
- MATERIAL:  
HOUSING: LCP, BLACK, UL 94V-0  
CONTACT: PHOSPHOR BRONZE, T=0.08MM  
SHELL: STAINLESS STEEL T=0.10MM
  - FINISH:  
CONTACT: NI 50u"min PLATING OVER ALL,  
GOLD FLASH (Au 1u"-3u") ON THE CONTACT  
AREA AND SOLDER AREA  
SHELL: SELECTIVE GOLD FLASH IN SOLDER TAIL AREA  
NI 50u"min PLATING OVER ALL
  - GP PASSED ACCORD WITH HRD-RoHS-219 STANDARD.
  - ALL DIMENSIONS MARKED  $\nabla$  MUST BE CONTROLLED EVERYDAY BY QC  
MARKED  $\nabla$  PER WORK WEEK AND  $\nabla$  PER MONTH  
MUST BE CONTROLLED.
  - ALL DIMENSIONS MARKED (XX) MUST BE CONTROLLED BY QC.

RECOMMENDED PCB LAYOUT  
GENERAL TOLERANCE  $\pm 0.05$



PIIN/NO.	ASSIGNMENT
C1	Vcc(SUPPLY VOLTAGE)
C2	RST(RESET SIGNAL)
C3	CLK (CLOCK SIGNAL)
CD	DETECT SEITCH
C5	GND
C6	Vpp (VARIABLE SUPPLY BOLTAGE)
C7	I/O (DATA INPUT/OUTPUT)

				UNITS: mm	GENERAL TOLERANCE		DRAW:	PART NO:
				DATE: 03/15/2017	X. $\pm 0.20$	X' $\pm 2.00$	CHECKED:	TITLE: 1.35H NANO SIM CARD CONN.
				SCALE: 8 / 1	.XX $\pm 0.10$	.XX' $\pm 0.50$	APPROVE:	DRAWING NO:
				SHEET: 1 / 2	.XXX $\pm 0.05$	.XXX' $\pm 0.10$		
REV.	ECN NO.	DESCRIPTION	DATE	REV. A	MATERIAL:		 <b>昆山捷皇电子精密科技有限公司</b> HONGRIDA ELECTRONIC TECHNOLOGY CO., LTD.	
					FINISH: SEE NOTE			